

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

# STF40NF06

### N-channel 60V - 0.024Ω - 23A - TO-220FP STripFET™ II Power MOSFET

### **General features**

Туре	V <sub>DSS</sub>	R <sub>DS(on)</sub>	ID
STF40NF06	60V	<0.028Ω	23A

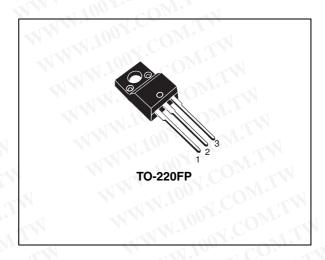
- Exceptional dv/dt capability
- Low gate charge at 100°C
- Application oriented characterization
- 100% avalanche tested

### Description

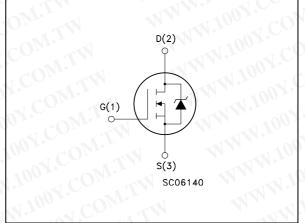
This MOSFET is the latest development of STMicroelectronics unique "Single Feature Size™" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalance characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

### Applications

Switching application



### Internal schematic diagram



### **Order codes**

Part number	Marking	Package	Packaging
STF40NF06	F40NF06	TO-220FP	Tube

September 2006	Rev 3	1/12
	WW W.100X. COM. I	www.st.com

# DY.COM.TW Contents

# COM Contents

CONT.IM

1	Electrical ratings
2	Electrical characteristics
	2.1 Electrical characteristics (curves)
3	Test circuit
4	Package mechanical data
5	Revision history

WWW.100Y.COM.TW

EW.100Y.COM.TW

N.COM.TW

WWW.100Y.COM.TW

WWW.100Y.COM.TW

WWW.1001.COM.TW

WWW.100X.COM

57

WWW.100Y.COM.TW

NW100X.COM.TW

WWW.1001.COM.TW

WWW.100X.COM

WWW.100Y.COM.TW

11

### **Electrical ratings** WWW

<b>Electrical ratings</b>	
on Y. CO. M. TW	

able 1.	Absolute maximum ratings	CO. CAN	
Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage (V <sub>GS</sub> = 0)	60 60	V
V <sub>GS</sub>	Gate-source voltage	± 20	V
I <sub>D</sub>	Drain current (continuous) at $T_C = 25^{\circ}C$	23	A
Ι <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> =100°C	16	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	92	А
P <sub>TOT</sub>	Total dissipation at $T_{C} = 25^{\circ}C$	30	W
N.	Derating Factor	0.2	W/°C
dv/dt <sup>(2)</sup>	Peak diode recovery voltage slope	10 00	V/ns
E <sub>AS</sub> <sup>(3)</sup>	Single pulse avalanche energy	250	mj
V <sub>ISO</sub>	Insulation withstand voltage (RMS) from all three leads to external heat sink (t=1s; Tc= 25°C)	2500	ON V
T <sub>J</sub> T <sub>stg</sub>	Operating junction temperature Storage temperature	-55 to 175	°C
		-11.	×1 U

WWW.100Y.COM.TW

W.100X.COM.TW

CONT.TW

WW.100Y.COM.TW

WWW.100Y.COM.TW

WWW.100X

ELOOX.COM.TW

WWW.100Y.COM.TW

WWW.100X.COM

OM.TW

Table 2.	Thermal	data
----------	---------	------

Table 2.   R <sub>thj-case</sub>	Thermal data       Thermal resistance junction-case Max	5.0	°C/V
CONTL	Maximum lead temperature for soldering purpose	275	°C

WWW.100Y.COM.TW

WWW.1001.

NIDOX.COM.TW

WWW.100Y.COM

1007.COM

V.100X.CON

W.100Y.CC

WW.100X.C

**\_\_\_** 

2 WWW.I

CASE=2	5°C unless otherwise speci	fied)				
Table 3.	On/off states	WWW.100Y.CC	DW.J	W		
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0$	60	M.TY	I	V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	$V_{DS}$ = Max rating, $V_{DS}$ = Max rating @125°C	N.C.	ONL	1 10	μΑ μΑ
I <sub>GSS</sub>	Gate body leakage current (V <sub>DS</sub> = 0)	$V_{GS} = \pm 20V$	1001	$c_{O_{Z_{i}}}$	± 100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$	2		4	v
R <sub>DS(on)</sub>	Static drain-source on resistance	V <sub>GS</sub> = 10V, I <sub>D</sub> = 11.5A	N.10	0.024	0.028	Ω

WWW.100Y.COM.TW

W.100X.COM.TW

<u>+C</u>ON.TW

100X.COM

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	
g <sub>fs</sub> <sup>(1)</sup>	Forward transconductance	V <sub>DS</sub> = 30V, I <sub>D</sub> = 11.5A	1VV	12	001.	
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>DS</sub> =25V, f=1 MHz, V <sub>GS</sub> =0	4	920 225 80	1001 N.100	
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total gate charge Gate-source charge Gate-drain charge	$V_{DD}$ =48V, $I_{D}$ = 10A $V_{GS}$ =10V		32 6.5 15	43	2

WWW.100Y.COM.TW

WW100X.COM.TW

WWW.1002.COM.TW

WWW.100Y.COM

WWW.100Y.COM.TW

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub>	Turn-on Delay Time Rise Time	$\label{eq:VDD} \begin{array}{l} V_{DD} = 30 \text{V}, \ \text{I}_D = 20 \text{A}, \\ \text{R}_{\text{G}} = 4.7 \Omega, \ \text{V}_{\text{GS}} = 10 \text{V} \\ \text{(see Figure 13)} \end{array}$	1.17	27 11		ns ns
t <sub>d(off)</sub> t <sub>f</sub>	Turn-off-delay time Fall time	$V_{DD} = 30V, I_D = 20A,$ $R_G = 4.7\Omega, V_{GS} = 10V$ (see Figure 13)	COM	27 11	1	ns ns

WWW.100Y.COM.TW

WWWW100Y.COM.TW

WWW.1001.COM

WWW.100Y.COM

### Switching times

S	ymbol	Parameter	Test conditions	Min	Тур.	Max	Unit
1.17	I <sub>SD</sub>	Source-drain current	NN.100 - CO	E.	I	23	Α
IS	SDM <sup>(1)</sup>	Source-drain current (pulsed)	N. 100 . CC	DINT .	Z	92	А
V	/SD <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> =23A, V <sub>GS</sub> =0	ON.	N	1.3	V
N N	t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	I <sub>SD</sub> =40A, di/dt = 100A/µs, V <sub>DD</sub> =10V, Tj=150°C (see Figure 15)		63 150 4.8	N7	ns nC A

WWW.100Y.COM.TW

W.100X.COM.TW

COM.TW

Source drain diode

CONTLAN

Pulsed: pulse duration=300µs, duty cycle 1.5% 2. WWW.100X.COM

WWW.100Y.COM.TW

WWW.1001.

THOM.COM.TW

WWW.100Y.COM

WWW.100Y.COM.TW

<u>.co</u>M.TW



WWW.100Y.COM.TW

WWW.100Y.COM.TW

WWW.100X.COM

### **Electrical characteristics (curves)** 2.1 Safe operating area Figure 2. **Thermal impedance** Figure 1. l₀(A) δ : Ô 0.2 10<sup>2</sup> 0.1 10 100µs 0.05 10<sup>1</sup> 1ms 0.01 10ms $Z_{th} = k R_{thJ-c}$ $\delta = t_p / \tau$ 10 10<sup>0</sup> PULSI 10<sup>-1</sup> 10 <sup>68</sup>10<sup>0</sup> <sup>68</sup>10<sup>1</sup> <sup>8</sup>10<sup>2</sup> 4 6 8 VDS(V) 10<sup>-1</sup> 10<sup>0</sup> † p (s) 10-5 10-4 10-3 10<sup>-2</sup> 10-1



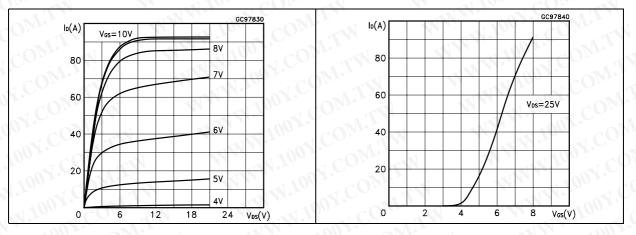


Figure 4.



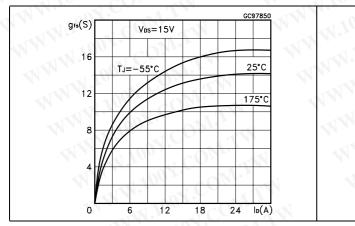
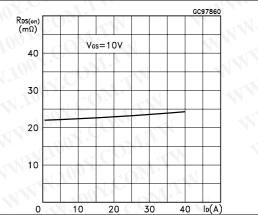


Figure 6. Static drain-source on resistance

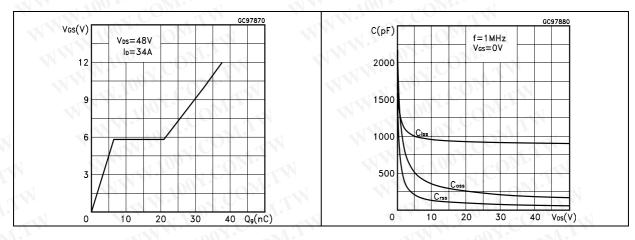
**Transfer characteristics** 



WWW.100Y.COM

47/

6/12



### Figure 7. Gate charge vs gate-source voltage Figure 8. Capacitance variations

Figure 9. Normalized gate threshold voltage Figure 10. Normalized on resistance vs vs temperature temperature

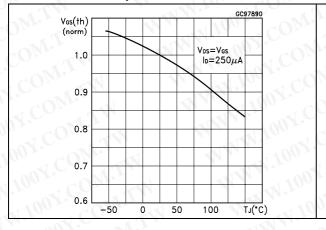


Figure 11. Source-drain diode forward characteristics

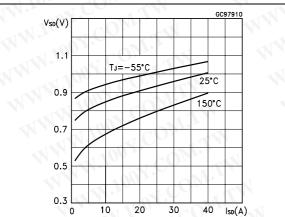
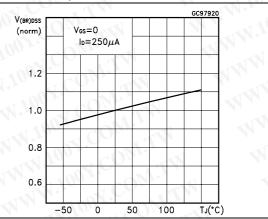


Figure 12. Normalized breakdown voltage vs temperature

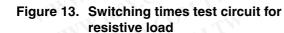


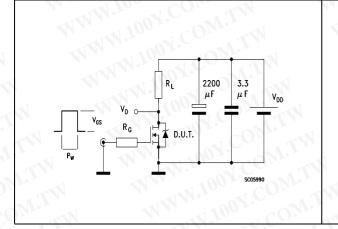
WWW.100Y.COM

57

7/12

# 3 Test circuit





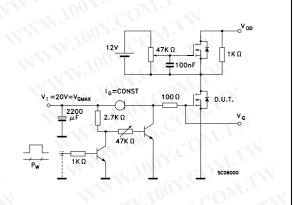
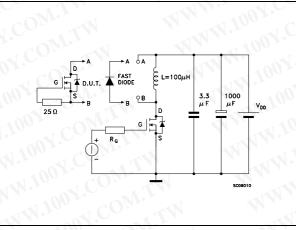
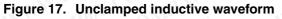
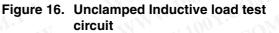


Figure 15. Test circuit for inductive load switching and diode recovery times







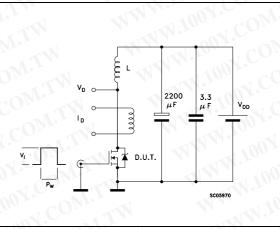
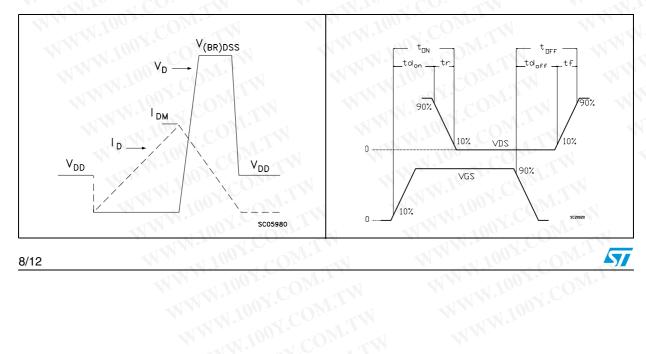


Figure 18. Switching time waveform



### Figure 14. Gate charge test circuit

4

### Package mechanical data

WWW.100Y.COM.TW

WWW.100

WWW.100X.CON

100X.COM.TW

WWW.100Y.COM.TW

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com WWW.100Y.COM

100Y.COM.TW



WWW.100Y.COM.TW

WWW.1007

100Y.COM.TW

WWW.100X.COM

WWW.100Y.COM.TW

V.CONTIN

DIM.	CON.	mm.		1100-	inch	-
DIM.	MIN.	ТҮР	MAX.	MIN.	TYP.	MAX.
A	4.4	17	4.6	0.173	1 COM	0.181
В	2.5	1.1	2.7	0.098	No.	0.106
D	2.5	WT.	2.75	0.098		0.108
E	0.45	Nr.	0.7	0.017		0.027
F	0.75		1	0.030		0.039
F1	1.15	One al	1.7	0.045	100	0.067
F2	1.15		1.7	0.045		0.067
G	4.95	CON A	5.2	0.195		0.204
G1	2.4	-011.	2.7	0.094	100	0.106
Ĥ	10		10.4	0.393	No.	0.409
L2	100	16	A		0.630	
L3	28.6	1.	30.6	1.126		1.204
L4	9.8		10.6	.0385	N.IV.	0.417
L5	2.9	001.	3.6	0.114		0.141
L6	15.9		16.4	0.626		0.645
L7	9	100 -	9.3	0.354		0.366
Ø	3		3.2	0.118	ANN AN	0.126

# NW.100X.COM.TW **TO-220FP MECHANICAL DATA**

WWW.100Y.COM.TW

WWW.100

W.100Y.COM.TW

WWW.100Y.COM

CONTAN

CONTLAN

WWW.100Y.COM.TW

WWW.1002.

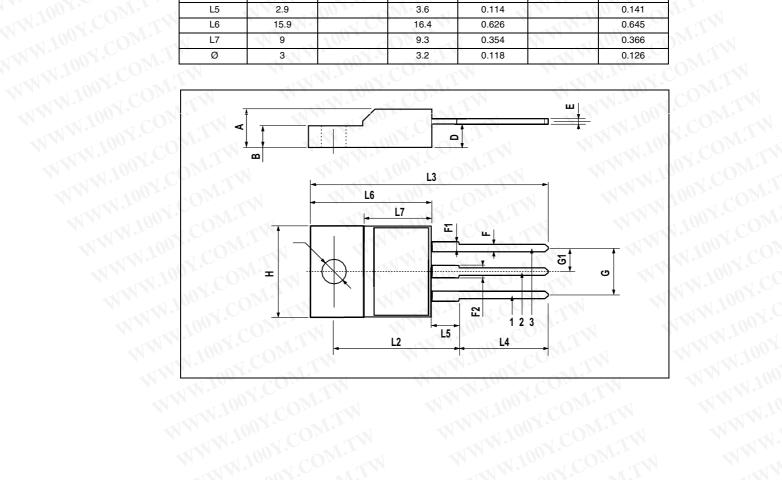
WW

THOOX.COM.TW

WWW.100Y.COM

57

WWW.100Y.COM.TW



WWW.100Y.COM.TW

WWW.1001.

THOM. COM. TW

WWW.100Y.COM

WWW.100Y.COM.TW

COM.TW

5 WW.10 WWW.1

### **Revision history**

COM.TW

1001		nstory
Table 7.	Revi	sion history
Date		Pevision

WWW.100Y.COM.TW

WW 100X.COM.TW

WWW.1001.COM.TW

WWW.100X.COM

WWW.100Y.COM.TW

Date	Revision	Changes
2-Nov-2004	N.Y	First release
7-May-2005	2	Final datasheet
4-Sep-2006	3	New template, no content change

WWW.100Y.COM.TW

TW.100Y.COM.TW

WWW.100Y.COM

HCON.TW



WWW.100Y.COM.TW

WWW.100Y.COM

### Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2006 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com